

(19) World Intellectual Property Organization
International Bureau



(43) International Publication Date
29 May 2008 (29.05.2008)

PCT

(10) International Publication Number
WO 2008/061468 A1

(51) International Patent Classification:

F21S 6/00 (2006.01) *F21Y 101/00* (2006.01)
F21V 29/00 (2006.01)

(21) International Application Number:

PCT/CN2007/071018

(22) International Filing Date:

5 November 2007 (05.11.2007)

(25) Filing Language:

English

(26) Publication Language:

English

(30) Priority Data:

06112953.4 24 November 2006 (24.11.2006) HK

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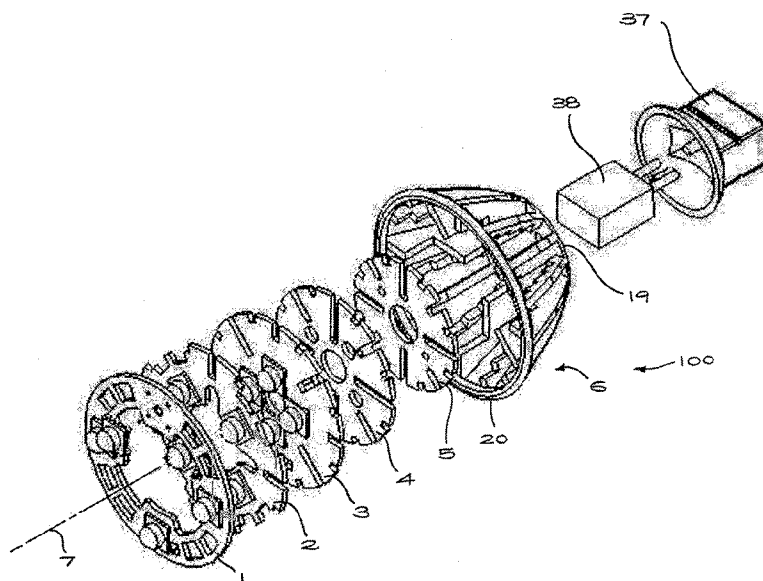
(81) Designated States (unless otherwise indicated, for every kind of national protection available): AE, AG, AL, AM, AT, AU, AZ, BA, BB, BG, BH, BR, BW, BY, BZ, CA, CH, CN, CO, CR, CU, CZ, DE, DK, DM, DO, DZ, EC, EE, EG, ES, FI, GB, GD, GE, GH, GM, GT, HN, HR, HU, ID, IL, IN, IS, JP, KE, KG, KM, KN, KP, KR, KZ, LA, LC, LK, LR, LS, LT, LU, LY, MA, MD, ME, MG, MK, MN, MW, MX, MY, MZ, NA, NG, NI, NO, NZ, OM, PG, PH, PL, PT, RO, RS, RU, SC, SD, SE, SG, SK, SL, SM, SV, SY, TJ, TM, TN, TR, TT, TZ, UA, UG, US, UZ, VC, VN, ZA, ZM, ZW.

(84) Designated States (unless otherwise indicated, for every kind of regional protection available): ARIPO (BW, GH, GM, KE, LS, MW, MZ, NA, SD, SL, SZ, TZ, UG, ZM, ZW), Eurasian (AM, AZ, BY, KG, KZ, MD, RU, TJ, TM), European (AT, BE, BG, CH, CY, CZ, DE, DK, EE, ES, FI, FR, GB, GR, HU, IE, IS, IT, LT, LU, LV, MC, MT, NL, PL, PT, RO, SE, SI, SK, TR), OAPI (BF, BJ, CF, CG, CI, CM, GA, GN, GQ, GW, ML, MR, NE, SN, TD, TG).

Published:

— with international search report

(54) Title: LIGHT EMITTER ASSEMBLY



(57) Abstract: A light emitter assembly (100) comprises a plurality of disc-shaped substrates (1,2,3) and a metal housing (6). The substrates (1,2,3) carry light emitters (8,9,10) and are axially stacked, spaced apart, in the housing (6) to dissipate the heat produced by the light emitters (8,9,10). The housing (6) comprises elongate planar ribs (16,17,18) that abut the light emitters (8,9,10) or substrates (1,2,3) for thermally connecting the light emitters (8,9,10) to the housing (6). The ribs (16,17,18) have shoulders (22-26). The substrates (1,2,3) are received between the ribs (16,17,18) and abut the shoulders (22-26). The shoulders (22-26) are adjacent to each light emitter (8,9,10) in intimate contact with the substrate (1,2,3) for efficient heat dissipation.

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Light Emitter Assembly

Technical field

- 5 This invention relates to light emitting assemblies having heat dissipating supports for reducing the operating temperature of the assembly.

Background of the Invention

- 10 Light sources comprising assemblies of light emitters such as light emitting diodes (LEDs) are finding increasing application in mass production applications because of their high efficiency and long life. One such application is light sources for replacing florescent and incandescent lights and the like.
- 15 High output LEDs, particularly when a large number are used on a common support, produce a significant amount of heat. If elevated temperatures are then produced, the life of the LEDs is reduced. In practice, it is desirable that the LED be placed into contact with heat dissipation surfaces to effectively cool the LED. One such arrangement is described in the applicant's pending application no. 60/830,110. While this device performs
- 20 satisfactorily, it will be appreciated that there is an ongoing need for an improved assembly capable of mounting a large number of light emitters and one which can be produced economically. The assembly should include a great deal of heat transfer potential in addition to providing a means for further incorporating the light emitter into the circuitry of an overall lighting assembly.

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Disclosure of the Invention

According to one aspect of the invention there is provided a light emitter assembly, comprising:

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a substrate carrying a plurality of light emitters, and

a housing including mutually connected thermally conductive ribs spaced apart for air flow therebetween, the substrate supported generally transversely between the ribs, the ribs abutting the light emitters or substrate for thermally connecting the light emitters or substrate to the housing.

5

In another aspect the invention provides a light emitter assembly, comprising:

first and second substrates carrying first and second pluralities of light emitters respectively,

10

a housing including mutually connected metal ribs spaced apart for air flow therebetween, both substrates extending generally transversely between the ribs with the second substrate spaced apart from the first substrate for air flow therebetween, the ribs having shoulders abutting the light emitters or substrates and thermally connecting the light emitters to the housing.

15

Preferably the substrates are formed of sheet material, each substrate having a respective peripheral edge and respective planar inner and outer faces, the outer faces being aligned generally parallel, the ribs surrounding the peripheral edges of the substrates, the first substrate having a recess such that light emitted outward from each of the second plurality of light emitters in a direction perpendicular to the outer faces passes through the recess and is not occluded by the first substrate.

20

Preferably a mounting portion of each outer face abuts each light emitter, and one of said shoulders abuts a portion of the inner face opposite each mounting portion.

25

Preferably the ribs extend radially relative to a central axis of the housing and are mutually connected at the longitudinally inner ends thereof. In a preferred embodiment the ribs are also mutually connected by a ring portion at the longitudinally outer ends thereof.

30

The first and second pluralities of light emitters are preferably mounted substantially upon respective first and second pitch circles centred on the central axis, the diameter of the first

pitch circle exceeding the diameter of the second pitch circle, the light emitters of the first plurality being circumferentially offset relative to the light emitters of the second plurality.

5 The substrates are preferably ring shaped, most preferably being formed from planar sheet material.

The assembly preferably further includes at least one generally transversely extending metal heat dissipation member connected to the ribs intermediate the inner and outer ends. Preferably the heat dissipation member is slotted to receive and engage each of the ribs.

10

The housing preferably has a substantially frustoconical periphery defined by the circumferentially spaced radially outermost edges of the ribs.

In another aspect the invention provides a light emitter assembly, comprising:

15

first and second substrates carrying first and second pluralities of light emitters respectively,

20 a housing including mutually connected metal ribs spaced apart for air flow therebetween and extending between an inner and an outer end of the housing, wherein

the substrates extend generally transversely between the ribs, the second substrate being spaced apart inwardly from the first substrate for air flow therebetween, the first substrate having a recess such that light emitted outward from each of the second plurality of light emitters in the longitudinal direction faces passes through the recess and is not occluded by the first substrate, and the ribs abutting the light emitters or substrates for thermally connecting the light emitters to the housing.

25 This invention provides an light emitter assembly having satisfactory light dispersion or radiation pattern and a simple design with a reduced number of parts to minimize manufacturing costs. Heat is efficiently dispersed into the housing and the spacings between the ribs of the housing, as well as between the substrates themselves, enhance the

heat transfer rate through natural convection in different orientations of the assembly.

Brief Description of the Drawings

- 5 Preferred forms of the present invention will now be described by way of example with reference to the accompanying drawings, wherein:

Figure 1 is a pictorial view of an light emitter assembly of the present invention;

- 10 Figure 2 is an exploded view of the assembly of Fig. 1;

Figures 3-5 are outer end views of substrates of the assembly of Fig. 1;

Figure 6 is an end view of the housing of the assembly of Fig. 1;

15

Figure 7 is an enlarged section illustrating the connection between a rib and substrate;

Figure 8 is a section along line AA of Fig. 6 showing an outer substrate in dashed outline;

- 20 Figure 9 is a section along line BB of Fig. 6 showing an inner substrate in dashed outline;

Figure 10 is a section along line CC of Fig. 6 showing an intermediate substrate in dashed outline, and

- 25 Figure 11 is detail of the electrical connection between the substrates.

Description of the Preferred Embodiments

- Referring to Figs 1 and 2, a light emitter assembly 100 includes three light emitter
30 substrates 1, 2, 3 and two heat dissipating members 4, 5 which are stacked in a housing 6. The components 1- 5 are substantially parallel, extending transversely relative to a central longitudinal axis 7. In the embodiment illustrated the LED substrates 1, 2, 3 and heat

dissipating members 4, 5 are in a generally planar ring shape, but it will be understood that different shapes will be equally applicable depending upon the required application of the assembly.

- 5 Each LED substrate 1, 2, 3 has an outer surface 1a, 2a, 3a and an opposing inner surface 1b, 2b, 3b. Four LEDs 8, 9, 10 are mounted on the respective outer surfaces 1a, 2a, 3a equally angularly spaced on respective pitch circles 11, 12, 13 centred on the central axis 7 and emitting light substantially parallel to the axis 7.
- 10 The LEDs on the three substrates 1, 2, 3 are offset radially, the pitch circle diameter 11 exceeding pitch circle diameter 12, and pitch circle diameter 12 exceeding pitch circle diameter 13. The LEDs of adjacent pairs of substrates 1, 2 and 2, 3 are circumferentially offset by 45°. Substrate 1 has a central recess 14 with four indentations 14a-14d circumferentially offset by 45° from the LEDs 8 for registration with the LEDs 9, such that
- 15 light emitted outward from each of the LEDs 9 is not occluded by the substrate 1. Likewise, substrate 2 has a recess 15 with four equally angularly spaced indentations 15a-15d for axial registration with the LEDs 10. In this manner the LEDs 8, 9, 10 are not blocked by each other or the substrates. Alternatively, transparent windows or substrates may be used for enhancing light emission efficiency in alternate embodiments.

20

In the embodiment shown, each substrate 1, 2, 3 is formed with a thermally conductive material such as metal-core printed circuit board (MC-PCB) or ceramic based substrate, for assisting heat distribution in each substrate. The MC-PCBs or ceramic based substrates are patterned to provide electrical paths (not shown) thereon for powering the LEDs as

25 generally understood by those skilled in the art.

- Referring to Figs 6-10, the housing 6 is a one-piece metal component, for example, of die-cast aluminium or magnesium for good thermal conductivity. The housing 6 generally comprises substantially planar and radially aligned ribs 16, 17, 18 elongated to join a disc-shaped inner portion 19 to an outer ring 20.
- 30

Four ribs 16 are equally angularly spaced, each having a radially outermost edge 21, an

inner shoulder 22 and an outer shoulder 23. Each of the shoulders 22, 23 has a respective transversely aligned shoulder surface 22a, 23a. The substrate 1 abuts the shoulder surface 23a below the LEDs 8 and the substrate 3 abuts the shoulder surfaces 22a below the LEDs 10.

5

Angularly offset from ribs 16 by 45° are four ribs 17 that are also are equally angularly spaced. Each rib 17 has a radially outermost edge 24, an inner shoulder 25 and an outer shoulder 26. Each of the shoulders 25, 26 has a respective transversely aligned shoulder surface 25a, 26a. The substrate 1 abuts the shoulder surfaces 25a and the substrate 2 abuts the shoulder surfaces 26a below the LEDs 9.

10

Fig. 7 illustrates the mounting portion 27 of outer face 2a which abuts each LED 9, by way of an illustration of the way all the heat dissipating ribs 16, 17 are fixed adjacent a respective LED. The shoulder surface 25a abuts the inner face 2b opposite each mounting portion 27 and is fixed by a thermally conductive adhesive for allowing efficient thermal connection between the ribs and the substrates. Optionally mechanical fasteners may also be used for joining the substrates and ribs.

15

Eight ribs 18 are equally angularly spaced, each having a radially outermost edge 35, and shoulders 30-34. The shoulders 30, 31, 32 abut the substrates 1, 2, 3 respectively and the shoulders 33, 34 abut the metal members 4, 5 and are likewise preferably fixed by thermally conductive adhesive. Each member 4, 5 extends transversely and is radially notched for receiving the ribs 16, 17, 18. With the substrates 1, 2, 3 and members 4, 5 physically spaced apart by a gap, more efficient thermal dissipation from the substrate to the environment, for example air surrounding the substrates, can be achieved. With the substrates thermally connected, heat will be transferred from a substrate of a higher temperature to a substrate of a lower temperature, and therefore more even thermal distribution among the substrates can be achieved.

25

The ribs 16, 17, 18 are splayed apart in the longitudinal direction, the housing 6 having a substantially frustoconical periphery defined by the circumferentially spaced radially outermost edges 21, 34, 35 of the ribs 16, 17, 18. Fixed to the inner portion 19 is a hollow

30

mounting fitting 37 which receives the electrical circuit 38 for supplying power to the LEDs 8, 9, 10.

5 A apertures 38, 39 in the substrate 1 are positioned between each LED 8 and are axially aligned with recesses 40, 41 in the substrate 2 for enhancing air flow through the substrates. The apertures 38-14 and the spacing between the ribs 16-18 provides satisfactory air flow and consequently enhance the thermal dissipation efficiency, regardless of the orientation of the assembly 100.

10 With the axial assembly of the substrates 1, 2, 3 into the housing, axially aligned pin-and-socket type connectors 42, 43, as shown in Fig. my provide the electrical connection between the substrates 1, 2, 3.

15 Aspects of the present invention have been described by way of example only and it should be appreciated that modifications and additions may be made thereto without departing from the scope thereof.

CLAIMS:

1. A light emitter assembly, comprising:
a substrate carrying a plurality of light emitters, and
5 a housing including mutually connected thermally conductive ribs spaced apart for air flow therebetween, the substrate supported generally transversely between the ribs, the ribs abutting the light emitters or substrate for thermally connecting the light emitters or substrate to the housing.
- 10 2. The assembly of claim 1 wherein the ribs have shoulders abutting the light emitters or substrate.
3. The assembly of claim 2 wherein the substrate includes a thermally conductive core, one of the shoulders abutting the substrate adjacent each emitter for thermally
15 connecting each light emitter to the housing.
4. The assembly of claim 3 further including at least one thermally conductive heat dissipation member fixed to the ribs and extending generally transversely between the ribs adjacent the substrate, the member being spaced apart from the adjacent
20 substrate for air flow therebetween.
5. The assembly of claim 4 wherein the ribs and each heat dissipation member are metal, the member abutting shoulders on the ribs.
- 25 6. A light emitter assembly, comprising:
first and second substrates carrying first and second pluralities of light emitters respectively,
a housing including mutually connected metal ribs spaced apart for air flow therebetween, the substrates extending generally transversely between the ribs with
30 the second substrate spaced apart from the first substrate for air flow therebetween, the ribs having shoulders abutting the light emitters or substrates for thermally connecting the light emitters to the housing.

7. The assembly of claim 6 wherein each substrate has a respective peripheral edge and respective planar inner and outer face, the outer faces being aligned generally parallel, the ribs surrounding the peripheral edges of the substrates, the first
5 substrate having a recess such that light emitted outward from each of the second plurality of light emitters in a direction perpendicular to the outer faces passes through the recess and is not occluded by the first substrate.
8. The assembly of claim 7 wherein a mounting portion of each outer face abuts each
10 light emitter, and one of said shoulders abuts a portion of the inner face opposite each mounting portion.
9. The assembly of claim 8 wherein the ribs extend radially relative to a central axis of the housing and are mutually connected at the longitudinally inner ends thereof.
15
10. The assembly of claim 9 wherein the ribs are mutually connected by a ring portion at the longitudinally outer ends thereof.
11. The assembly of claim 6 wherein the first and second pluralities of light emitters
20 are mounted substantially upon respective first and second pitch circles centred on the central axis, the diameter of the first pitch circle exceeding the diameter of the second pitch circle, the light emitters of the first plurality being circumferentially offset relative to the light emitters of the second plurality.
12. The assembly of claim 6 wherein the substrates are ring shaped.
25
13. The assembly of claim 12 wherein the substrates are formed from planar sheet material.
14. The assembly of claim 1 further including at least one generally transversely
30 extending metal heat dissipation member connected to the ribs and spaced apart from the adjacent substrate for air flow there between.

15. The assembly of claim 14 wherein each the heat dissipation member is substantially planar and abuts the shoulders.
- 5 16. The assembly of claim 15 wherein the heat dissipation member is slotted to receive and engage each of the ribs.
- 10 17. The assembly of claim 6 wherein the housing has a substantially frustoconical periphery defined by the circumferentially spaced radially outermost edges of the ribs.
18. A light emitter assembly, comprising:
first and second substrates carrying first and second pluralities of light emitters respectively,
15 a housing including mutually connected metal ribs spaced apart for air flow therebetween and extending between an inner and an outer end of the housing, wherein
the substrates extend generally transversely between the ribs, the second substrate being spaced apart inwardly from the first substrate for air flow
20 therebetween, the first substrate having a recess such that light emitted outward from each of the second plurality of light emitters in the longitudinal direction faces passes through the recess and is not occluded by the first substrate, and the ribs abutting the light emitters or substrates for thermally connecting the light emitters to the housing.
- 25 19. The assembly of claim 18 wherein shoulders formed on the ribs abut the light emitters or substrates for thermally connecting the light emitters to the housing.
- 30 20. The assembly of claim 18 wherein the substrate has opposing inner and outer faces, a mounting face portion of the outer face abuts each light emitter, and one of the shoulders abuts a portion of the inner face opposite each mounting portion.

21. The assembly of claim 18 wherein shoulders are formed on the ribs, the substrate has opposing inner and outer faces, a mounting face portion of the outer face abuts each light emitter, and one of the shoulders abuts a portion of the inner face opposite each mounting portion.
- 5
22. The assembly of claim 21 wherein the ribs are splayed apart in a longitudinal direction and each substrate has a peripheral edge; the ribs surrounding the peripheral edges of the substrates.
- 10
23. The assembly of claim 22 wherein the ribs extend radially relative to a central longitudinal axis of the housing and are mutually connected at the inner ends thereof.
- 15
24. The assembly of claim 22 wherein the ribs are mutually connected by a ring portion at the longitudinally outer ends thereof.
- 20
25. The assembly of claim 22 wherein the first and second pluralities of light emitters are mounted substantially upon respective first and second pitch circles centred on the central axis, the diameter of the first pitch circle exceeding the diameter of the second pitch circle, and the light emitters of the first plurality being circumferentially offset relative to the light emitters of the second plurality.
26. The assembly of claim 24 wherein the substrates are ring shaped.
- 25
27. The assembly of claim 26 wherein the substrates are formed from planar sheet material.
28. The assembly of claim 18 further including at least one generally transversely extending metal heat dissipation member connected to the ribs intermediate the inner and outer ends.
- 30
29. The assembly of claim 28 wherein each the heat dissipation member is

substantially planar and abuts the shoulders.

30. The assembly of claim 28 wherein the heat dissipation member is slotted to receive and engage each of the ribs.

5

31. The assembly of claim 22 wherein the housing has a substantially frustoconical periphery defined by the circumferentially spaced radially outermost edges of the ribs.

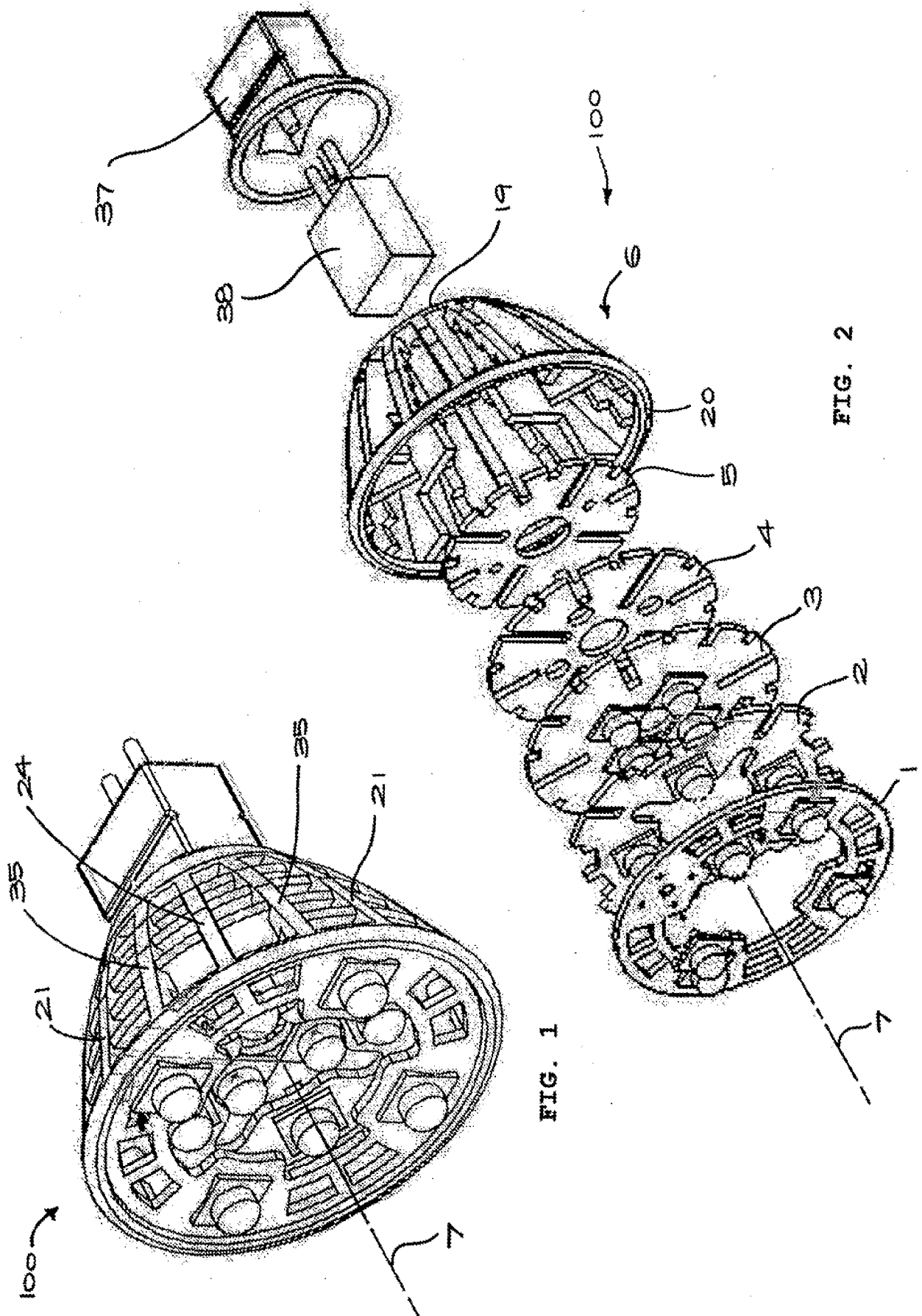


FIG. 1

FIG. 2

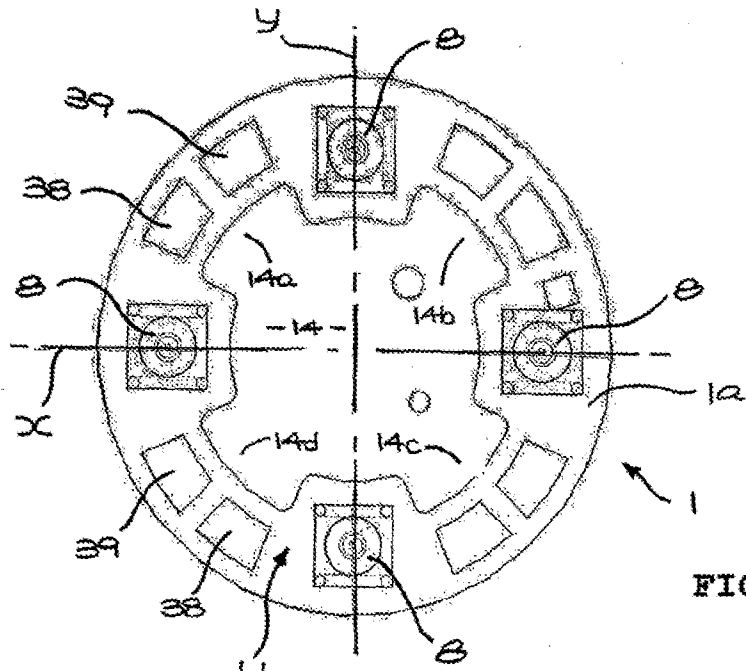


FIG. 3

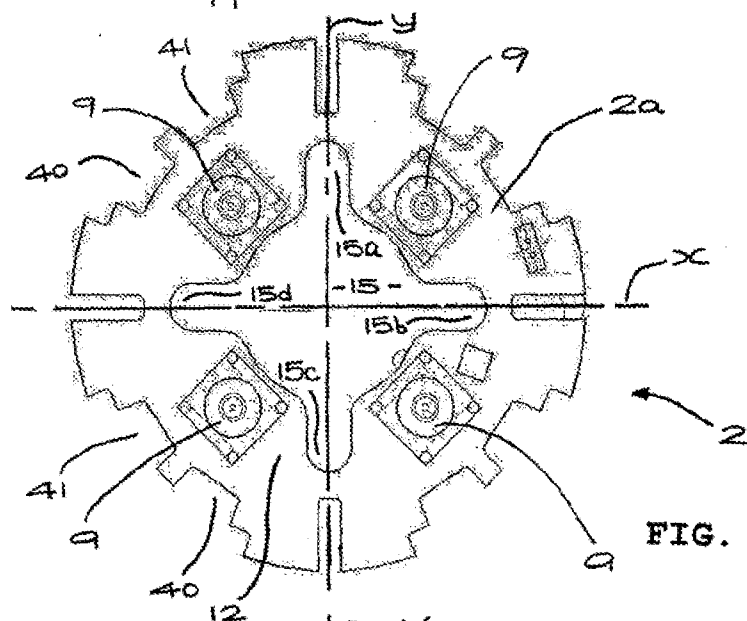


FIG. 4

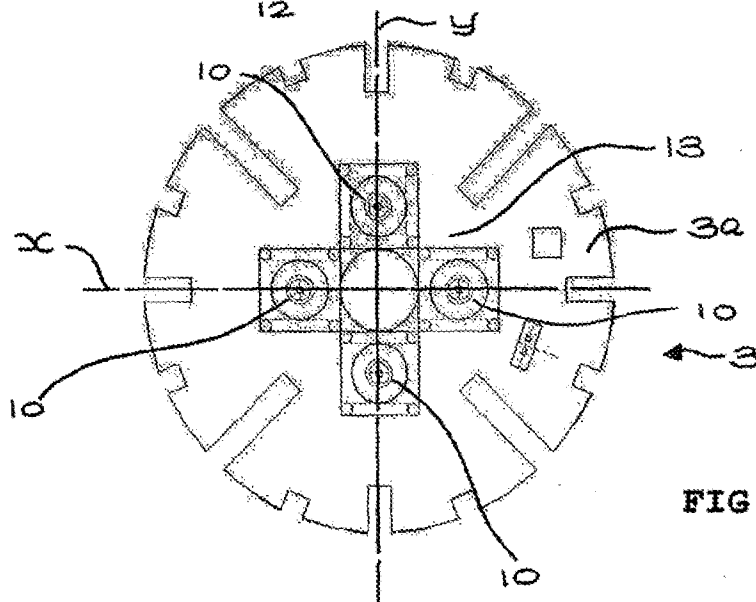
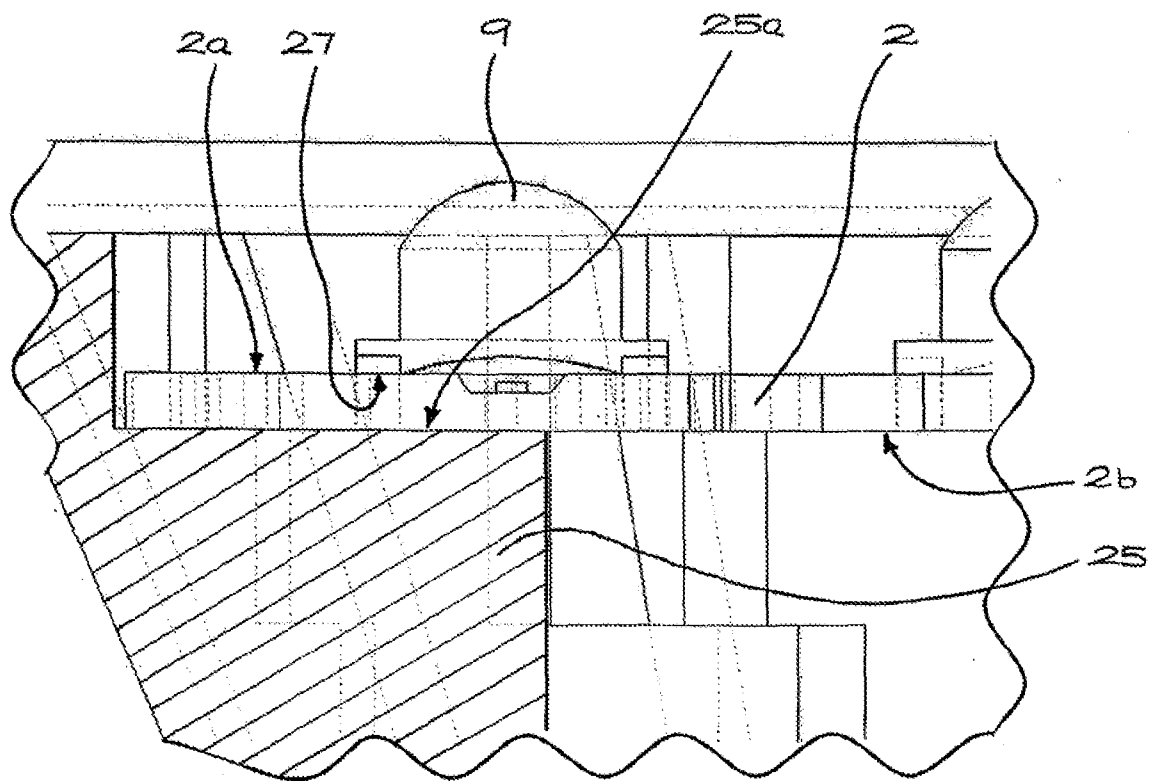
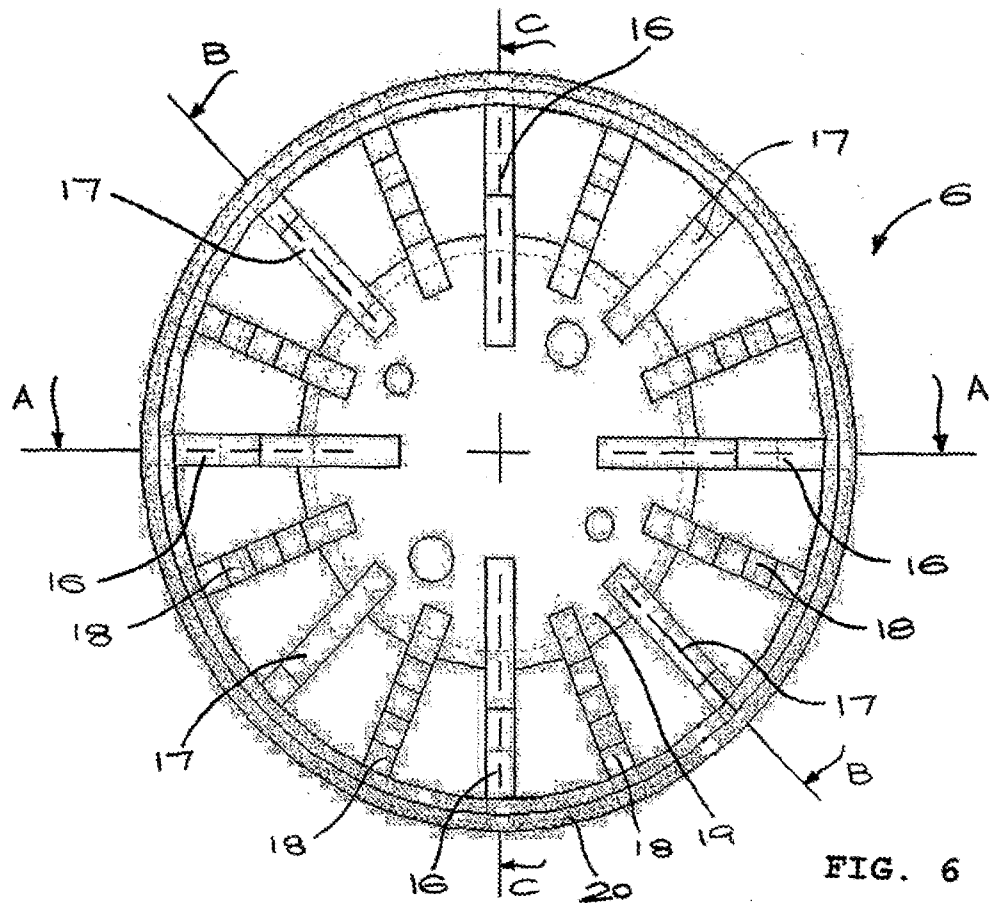


FIG. 5



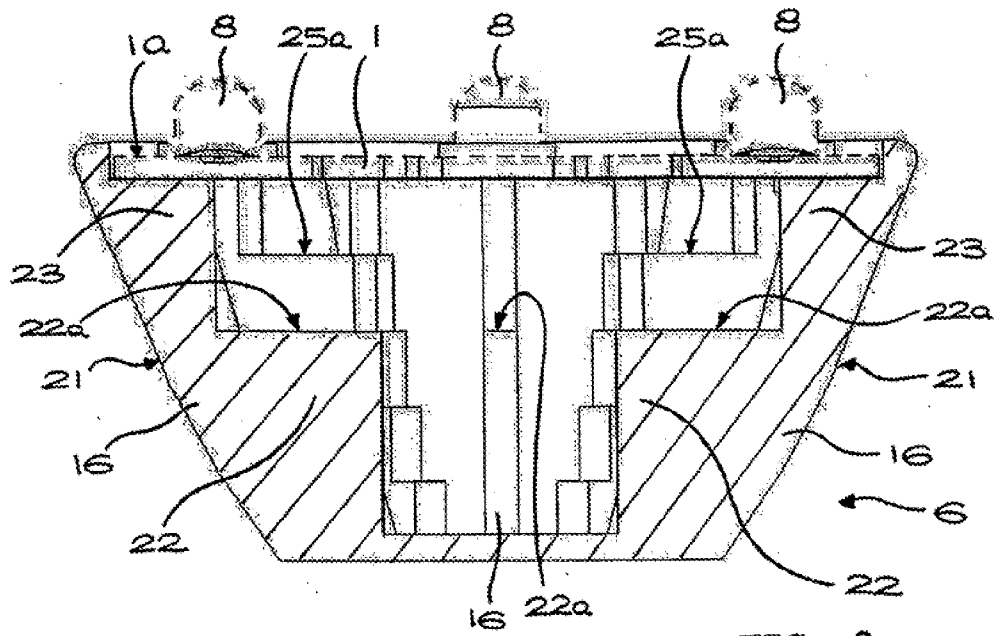


FIG. 8

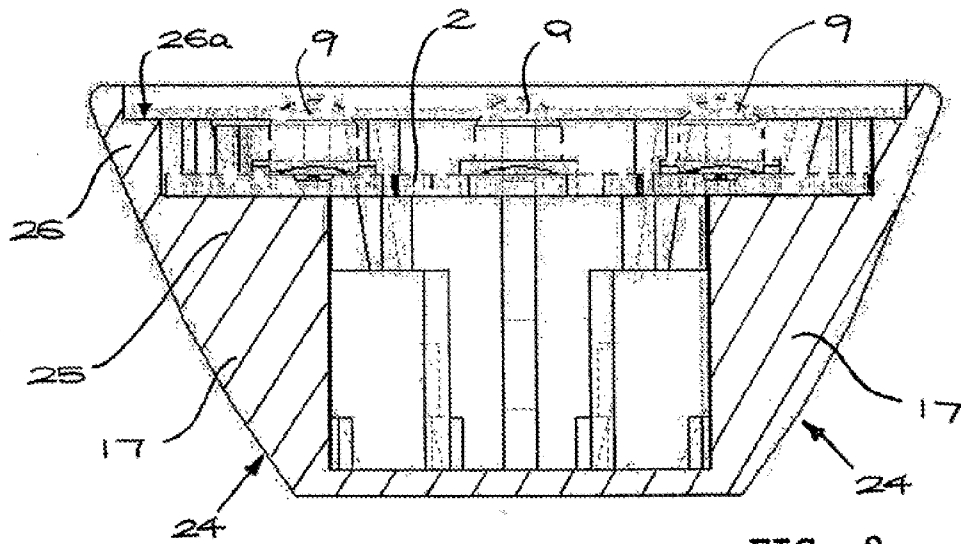


FIG. 9

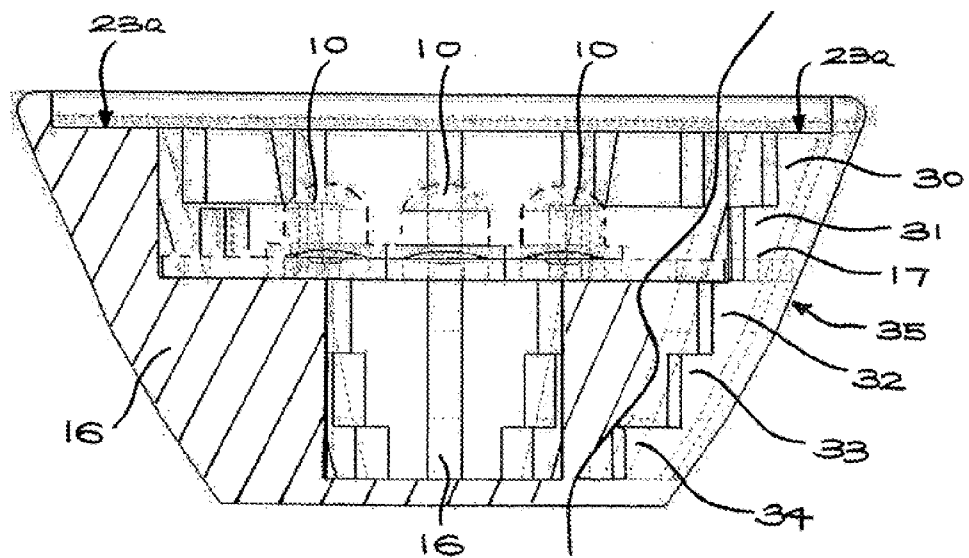


FIG. 10

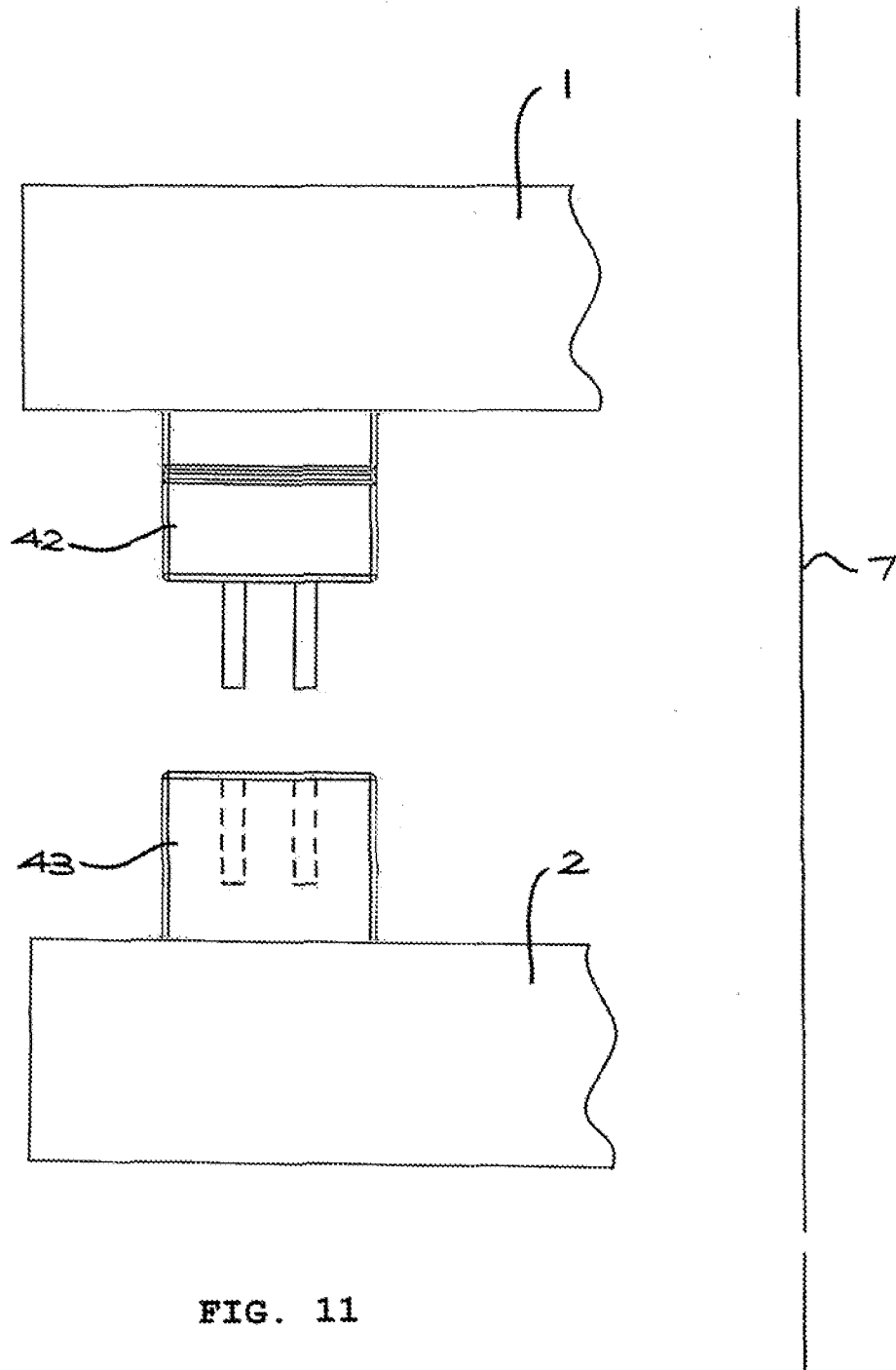


FIG. 11

INTERNATIONAL SEARCH REPORT

International application No.

PCT/CN2007/071018

A. CLASSIFICATION OF SUBJECT MATTER

See extra sheet

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

IPC: F21

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)

WPI, EPODOC, PAJ, CNPAT thermal+, heat, dissipat+, sink+, conduct+

C. DOCUMENTS CONSIDERED TO BE RELEVANT

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☒ Further documents are listed in the continuation of Box C.

☒ See patent family annex.

* Special categories of cited documents:	"I" later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention
"A" document defining the general state of the art which is not considered to be of particular relevance	"X" document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone
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Date of the actual completion of the international search
07 Jan.2008 (07.01.2008)

Date of mailing of the international search report
24 Jan. 2008 (24.01.2008)

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INTERNATIONAL SEARCH REPORT

International application No.

PCT/CN2007/071018

CLASSIFICATION OF SUBJECT MATTER

F21S 6/00 (2006.01) i

F21V 29/00 (2006.01) i

F21Y 101/00 (2006.01) n

INTERNATIONAL SEARCH REPORT

International application No.

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C (Continuation). DOCUMENTS CONSIDERED TO BE RELEVANT

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INTERNATIONAL SEARCH REPORT
Information on patent family members

International application No.

PCT/CN2007/071018

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